

### CO2016A SERIES: 2.0 x 1.6 mm CLOCK OSCILLATOR



#### ■ FEATURES

- ULTRA SMALL PACKAGE
- LOW SUPPLY VOLTAGE 1.6 AVAILABLE
- STANDBY FUNCTION
- RELIABILITY TESTING PER AEC-Q200

#### ■ ELECTRICAL SPECIFICATION

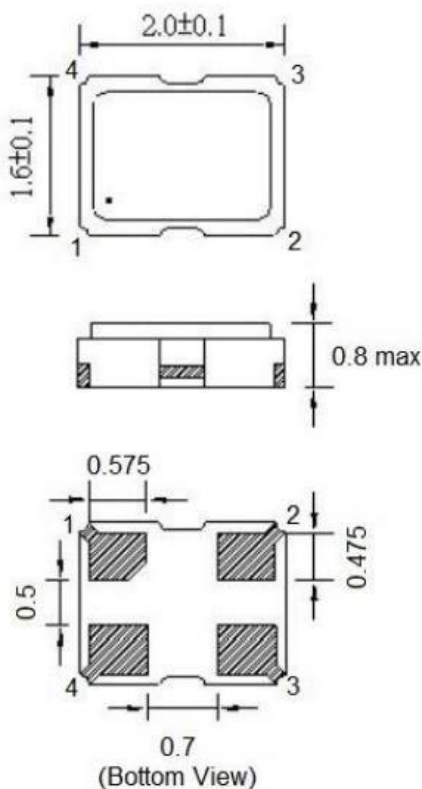
PARAMETER		VALUE	
Frequency Range		1.250 ~ 100.000 MHz	
Frequency Stability <sup>1</sup> *		±20**ppm, ±50 ppm, ±100 ppm	
Supply Voltage		1.6, 2.5, 3.3 V	
		1.6 ~ 3.3 V	
Supply Current		15 mA, max	
Output CMOS	Symmetry @50% Vdd	40% to 60% Standard	
		45% to 55% Tight	
	Rise / Fall Time	10 ns max at 10% to 90% Vdd	
	Logic “0” Level	Vcc x 0.1 V max	
	Logic “1” Level	Vcc x 0.9 V min	
Load		15 pF max	
Enable / Disable Function		Pin 1: Open or High, Pin 3: Oscillation (Enabled), min	Vcc x 0.7 V
		Pin 1: Low, Pin 3: High Impedance (Disabled), max	Vcc x 0.3 V
Start-up Time		10 ms max	
Jitter, RMS (12 kHz ~ 20 MHz)		1 ps max	
Standby Current		10µA max	
Operating Temperature Range		-40°C ~ +85°C	
		-40°C ~ +105°C	
		-40°C ~ +125°C	
Storage Temperature Range		-55°C ~ +125°C	

\* Inclusive of 25°C tolerance, operating temperature range, voltage and load changes, aging, reflow

\*\* Not available for all Temperature Ranges. Contact Factories

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### MECHANICAL SPECIFICATION (4 pin ceramic package)



OUTLINE TOLERANCE  
IF NOT SPECIFIED:  
±0.015" / 0.4mm

PIN FUNCTIONS:  
[1] ENABLE / DISABLE  
[2] GND  
[3] OUTPUT  
[4] VCC

### PART NUMBERING SYSTEM

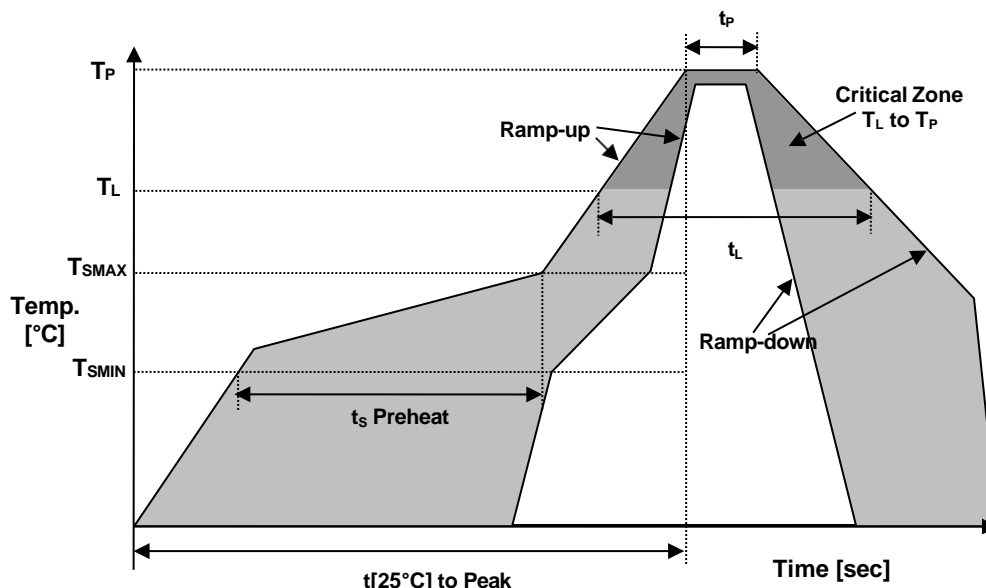
TYPE	SERIES	-	FREQUENCY (MHz)	-	SUPPLY VOLTAGE (Vcc)	-	STABILITY (ppm)	-	TEMPERATURE RANGE	-	SYMMETRY (Duty Cycle)	-	TAPE & REEL
Clock Oscillator CO	2016A	-	1.250 ~100.000	-	1.8: Vcc=1.8 2.5: Vcc=2.5 3.3: Vcc=3.3	-	20: ±20 50: ±50 100: ±100	-	X: -40°C ~+85°C X1: -40°C ~+125°C X6: -40°C ~ +105°C	-	blank: 40 ~ 60% T: 45 ~ 55%	-	TR

### EXAMPLE: CO2016A-50.000-3.3-50-X1-T-TR

Surface Mount Crystal Oscillators CO2016A, 2.0 x 1.6 mm, 50.000 MHz, 3.3 VDC Supply Voltage, ±50 ppm Overall Stability, from -40°C to +125°C, Symmetry 45% to 55%, Tape and reel packaging.

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#### REFLOW PROFILE



Reflow profile		
Temperature Min Preheat	$T_{SMIN}$	150°C
Temperature Max Preheat	$T_{SMAX}$	200°C
Time ( $T_{SMIN}$ to $T_{SMAX}$ )	$t_s$	60-180 sec.
Temperature	$T_L$	217°C
Peak Temperature	$T_P$	260°C
Ramp-up rate	$R_{UP}$	3°C/sec max.
Ramp-down rate	$R_{DOWN}$	6°C/sec max.
Time within 5°C of Peak Temperature	$t_p$	10 sec.
Time $t[25^\circ\text{C}]$ to Peak Temperature	$t[25^\circ\text{C}]$ to Peak	480 sec.
Time	$t_L$	60-150 sec.

#### ENVIRONMENTAL

PARAMETER	VALUE
MOISTURE SENSITIVITY LEVEL	1
REACH SVHC	Compliant
RoHS	Compliant
TERMINATION FINISH	Au



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The process of manufacturing **CO2016A** series of Automotive Grade Clock Oscillator is performed by using **Advanced Product Quality Planning (APQP)**. This technique defines and establishes the following actions:

- Product design activities communicating special characteristics to the process design activity, prior to design release, linking the DFMEA to PFMEA.
- Plan, acquire and install appropriate process equipment and tooling based on design tolerances provided by the customer. – CPPD (Collaborative Product Process Design)
- Assembly personnel communicating suggestions on better ways to assemble a product prior to the completion of the design of the product. – DFA/M (Design for Assembly and Manufacturing)
- Manufacturing or Process Engineering establishing adequate Quality Controls for features of a product or parameters of a process, which still risk potential failure. – Control Plan Methodology
- Performing Stability and Capability studies on special characteristics to understand the variation present and predict future performance. – SPC (Statistical Process Control and Process Capability)

Request for **Production Part Approval Process (PPAP)** documentation must be requested at time of order placement. Requests for part approval will be supported in official PPAP format and with documented results as requested at time of order placement. Actual measurements are taken of the parts produced and are used to complete the various test sheets of PPAP.

### • NOTICE

If you intend to use our product referenced above in an automotive application that may result in loss of life or assets, please do not fail to advise us of your intention beforehand. The use of the listed part in those applications is not covered by warranty, and we will not be held accountable for any liability claims. We reserve the right to not supply parts in those circumstances.